



Emerging Trends and Applications of Big Data Analytics and the Internet of Things for Future Smart Cities

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Deadline for manuscript submissions:

closed (31 August 2023)

Message from the Guest Editors

Dear Colleagues,

In recent years, the Internet of Things has been a notably evolving interdisciplinary research area for both academia and industry professionals. This Special Issue invites submissions with the scope and exploitation/fusion of Big Data Analytics (BDA) and the Internet of Things (IoT) and their applications for future smart cities.

Furthermore, this Special Issue invites the extended version of accepted manuscripts from the International Conference on Smart Computing and Application (ICSCA 2022). The conference will be organized by the College of Computer Science and Engineering, University of HA'IL, Saudi Arabia and will be held in hybrid (onsite and virtual) from 4-5 December 2022. This Special Issue is open to high-quality research contributions from a wide range of professions including scholars, researchers, academicians, and industry people. In this Special Issue, we hope to promote discussion and contributions towards innovative solutions. Furthermore, the aim is to focus on original research papers of high quality, providing practical applications for real-world problems and bridging the gap between industry and academia.





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Message from the Editor-in-Chief

As the world of science becomes ever more specialized, researchers may lose themselves in the deep forest of the ever increasing number of subfields being created. This open access journal *Applied Sciences* has been started to link these subfields, so researchers can cut through the forest and see the surrounding, or quite distant fields and subfields to help develop his/her own research even further with the aid of this multi-dimensional network.

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